Transistors

10V Drive Nch MOS FET RDX045N60

Structure

Silicon N-channel MOS FET

● Features

- 1) Low on-resistance.
- 2) Low input capacitance.
- 3) Excellent resistance to damage from static electricity.

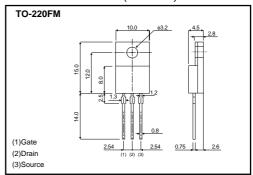
Applications

Switching

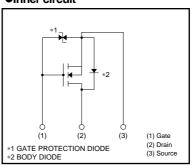
Packaging specifications

| | Package | Bulk |
|-----------|------------------------------|------|
| Type | Code | _ |
| | Basic ordering unit (pieces) | 500 |
| RDX045N60 | | 0 |

●External dimensions (Unit : mm)



●Inner circuit



● Absolute maximum ratings (Ta=25°C)

| Parameter | | Symbol | Limits | Unit | |
|-----------------------------------|------------|--------------------|-------------|------|--|
| Drain-source voltage | | VDSS | 600 | V | |
| Gate-source voltage | | Vgss | ±30 | V | |
| Drain current | Continuous | I _D *1 | ±4.5 | Α | |
| Drain current | Pulsed | I _{DP} *2 | ±18 | Α | |
| Source current (Body diode) | Continuous | Is | 4.5 | Α | |
| | Pulsed | I _{SP} *2 | 18 | А | |
| Avalanche current | | I _{AS} *3 | 4.5 | Α | |
| Avalanche energy | | E _{AS} *4 | 40 | mJ | |
| Total power dissipation (Tc=25°C) | | PD | 35 | W | |
| Channel temperature | | Tch | 150 | °C | |
| Range of storage temperature | | Tstg | -55 to +150 | °C | |
| | | | | | |

^{*1} Limited only by maximum temperature allowed *3 L \rightleftharpoons 3.4mH VDD=90V Rg=25 Ω *4 L \rightleftharpoons 3.4mH VDD=90V Rg=25 Ω starting Tch=25°C

Thermal resistance

| Parameter | Symbol | Limits | Unit |
|-----------------|-----------|--------|------|
| Channel to case | Rth(ch-c) | 3.57 | °C/W |

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●Electrical characteristics (Ta=25°C)

| Parameter | Symbol | Min. | Тур. | Max. | Unit | Conditions |
|---|------------------------|------|------|------|------|---|
| Gate-source leakage | Igss | - | _ | ±10 | μΑ | V _{GS} = ±25V, V _{DS} =0V |
| Drain-source breakdown voltage | V _{(BR) DSS} | 600 | _ | _ | V | I _D = 1mA, V _{GS} =0V |
| Zero gate voltage drain current | IDSS | _ | _ | 25 | μΑ | V _{DS} = 600V, V _{GS} =0V |
| Gate threshold voltage | V _{GS (th)} | 2.0 | _ | 4.0 | V | V _{DS} = 10V, I _D = 1mA |
| Static drain-source on-state resistance | R _{DS (on)} * | - | 1.6 | 2.1 | Ω | I _D = 2.25A, V _{GS} = 10V |
| Forward transfer admittance | Y _{fs} * | 1.5 | 2.8 | _ | S | V _{DS} = 10V, I _D = 2.25A |
| Input capacitance | Ciss | _ | 500 | _ | pF | Vps= 25V |
| Output capacitance | Coss | _ | 60 | _ | pF | Vgs=0V |
| Reverse transfer capacitance | Crss | - | 10 | _ | pF | f=1MHz |
| Turn-on delay time | t _{d (on)} * | - | 18 | _ | ns | V _{DD} ≒ 150V |
| Rise time | tr * | - | 16 | _ | ns | I _D = 2.25A V _G s= 10V |
| Turn-off delay time | t _{d (off)} * | - | 36 | _ | ns | R _L = 66.7Ω |
| Fall time | t _f * | - | 28 | _ | ns | R _G =10Ω |
| Total gate charge | Qg * | _ | 16 | _ | nC | V _{DD} ≒300V, V _{GS} =10V |
| Gate-source charge | Qgs * | | 4 | _ | nC | I _D = 4.5A |
| Gate-drain charge | Q _{gd} * | _ | 6 | _ | nC | $R_L=66.7\Omega$, $R_{GS}=10\Omega$ |

*Pulsed

●Body diode characteristics (Source-drain) (Ta=25°C)

| Parameter | Symbol | Min. | Тур. | Max. | Unit | Conditions |
|-------------------------|--------|------|------|------|------|--|
| Forward voltage | Vsp * | _ | _ | 1.5 | V | I _S = 4.5A, V _{GS} =0V |
| Reverse recovery time | trr | - | 400 | _ | ns | IDR= 4.5A, VGS=0V |
| Reverse recovery charge | Qrr | _ | 4.4 | _ | μC | di/dt= 100A / μs |

^{*}Pulsed

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